MJE18006G

Switch-mode

NPN Bipolar Power Transistor For Switching Power Supply Applications

The MJE18006G has an applications specific state−of−the−art die designed for use in 220 V line−operated switch−mode power supplies and electronic light ballasts.

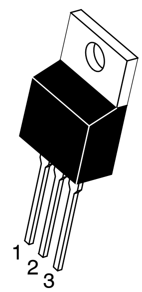
Features

- Improved Efficiency Due to Low Base Drive Requirements:
  - High and Flat DC Current Gain h_{FE}
  - Fast Switching
  - No Coil Required in Base Circuit for Turn−Off (No Current Tail)
- Tight Parametric Distributions are Consistent Lot−to−Lot
- Standard TO−220
- These Devices are Pb−Free and are RoHS Compliant*

ON Semiconductor®

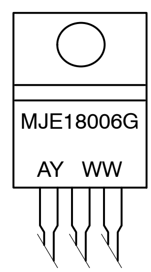
http://onsemi.com

POWER TRANSISTOR
6.0 AMPERES
1000 VOLTS − 100 WATTS



TO−220AB
CASE 221A−09
STYLE 1

MARKING DIAGRAM



A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector−Emitter Sustaining Voltage	V_{CEO}	450	Vdc
Collector−Emitter Breakdown Voltage	V_{CES}	1000	Vdc
Emitter−Base Voltage	V_{EBO}	9.0	Vdc
Collector Current − Continuous − Peak (Note 1)	I_C I_{CM}	6.0 15	Adc
Base Current − Continuous − Peak (Note 1)	I_B I_{BM}	4.0 8.0	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	100 0.8	W W/°C
Operating and Storage Temperature	T_J, T_{stg}	−65 to 150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction−to−Case	$R_{\theta JC}$	1.25	°C/W
Thermal Resistance, Junction−to−Ambient	$R_{\theta JA}$	62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8″ from Case for 5 Seconds	T_L	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Pulse Test: Pulse Width = 5 ms, Duty Cycle ≤ 10%.

ORDERING INFORMATION

Device	Package	Shipping
MJE18006G	TO−220 (Pb−Free)	50 Units / Rail

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

April, 2010 − Rev. 7
Publication Order Number:
MJE18006/D

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise specified)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector−Emitter Sustaining Voltage (I_C = 100 mA, L = 25 mH)	$V_{CEO(sus)}$	450	–	–	Vdc
Collector Cutoff Current (V_{CE} = Rated V_{CEO}, I_B = 0)	I_{CEO}	–	–	100	μAdc
Collector Cutoff Current (V_{CE} = Rated V_{CES}, V_{EB} = 0) (T_C = 125°C) (V_{CE} = 800 V, V_{EB} = 0) (T_C = 125°C)	I_{CES}	– – –	– – –	100 500 100	μAdc
Emitter Cutoff Current (V_{EB} = 9.0 Vdc, I_C = 0)	I_{EBO}	–	–	100	μAdc
ON CHARACTERISTICS					
Base−Emitter Saturation Voltage (I_C = 1.3 Adc, I_B = 0.13 Adc) (I_C = 3.0 Adc, I_B = 0.6 Adc)	$V_{BE(sat)}$	– –	0.83 0.94	1.2 1.3	Vdc
Collector−Emitter Saturation Voltage (I_C = 1.3 Adc, I_B = 0.13 Adc) (T_C = 125°C) (I_C = 3.0 Adc, I_B = 0.6 Adc) (T_C = 125°C)	$V_{CE(sat)}$	 – – – –	 0.25 0.27 0.35 0.4	 0.6 0.65 0.7 0.8	Vdc
DC Current Gain (I_C = 0.5 Adc, V_{CE} = 5.0 Vdc) (T_C = 125°C) (I_C = 3.0 Adc, V_{CE} = 1.0 Vdc) (T_C = 125°C) (I_C = 1.3 Adc, V_{CE} = 1.0 Vdc) (T_C = 25 to 125°C) (I_C = 10 mAdc, V_{CE} = 5.0 Vdc)	h_{FE}	14 – 6.0 5.0 11 10	– 32 10 8.0 17 22	34 – – – – –	–
DYNAMIC CHARACTERISTICS					
Current Gain Bandwidth (I_C = 0.5 Adc, V_{CE} = 10 Vdc, f = 1.0 MHz)	f_T	–	14	–	MHz
Output Capacitance (V_{CB} = 10 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	–	75	120	pF
Input Capacitance (V_{EB} = 8.0 V)	C_{ib}	–	1000	1500	pF
Dynamic Saturation Voltage: Determined 1.0 μs and 3.0 μs respectively after rising I_{B1} reaches 90% of final I_{B1} (see Figure 18) (I_C = 1.3 Adc, I_{B1} = 130 mAdc, V_{CC} = 300 V) 1.0 μs (T_C = 125°C)	$V_{CE(dsat)}$	– –	5.5 12	– –	V
(I_C = 1.3 Adc, I_{B1} = 130 mAdc, V_{CC} = 300 V) 3.0 μs (T_C = 125°C)		– –	3.0 7.0	– –	
(I_C = 3.0 Adc, I_{B1} = 0.6 Adc, V_{CC} = 300 V) 1.0 μs (T_C = 125°C)		– –	9.5 14.5	– –	
(I_C = 3.0 Adc, I_{B1} = 0.6 Adc, V_{CC} = 300 V) 3.0 μs (T_C = 125°C)		– –	2.0 7.5	– –	
SWITCHING CHARACTERISTICS: Resistive Load (D.C. ≤ 10%, Pulse Width = 20 μs)					
Turn−On Time (I_C = 3.0 Adc, I_{B1} = 0.6 Adc, I_{B2} = 1.5 Adc, V_{CC} = 300 V) (T_C = 125°C)	t_{on}	– –	90 100	180 –	ns
Turn−Off Time (T_C = 125°C)	t_{off}	– –	1.7 2.1	2.5 –	μs
Turn−On Time (I_C = 1.3 Adc, I_{B1} = 0.13 Adc, I_{B2} = 0.65 Adc, V_{CC} = 300 V) (T_C = 125°C)	t_{on}	– –	200 130	300 –	ns
Turn−Off Time (T_C = 125°C)	t_{off}	– –	1.2 1.5	2.5 –	μs
SWITCHING CHARACTERISTICS: Inductive Load (V_{clamp} = 300 V, V_{CC} = 15 V, L = 200 μH)					
Fall Time (I_C = 1.5 Adc, I_{B1} = 0.13 Adc, I_{B2} = 0.65 Adc) (T_C = 125°C)	t_{fi}	– –	100 120	180 –	ns
Storage Time (T_C = 125°C)	t_{si}	– –	1.5 1.9	2.5 –	μs
Crossover Time (T_C = 125°C)	t_c	– –	220 230	350 –	ns
Fall Time (I_C = 3.0 Adc, I_{B1} = 0.6 Adc, I_{B2} = 1.5 Adc) (T_C = 125°C)	t_{fi}	– –	85 120	150 –	ns
Storage Time (T_C = 125°C)	t_{si}	– –	2.15 2.75	3.2 –	μs
Crossover Time (T_C = 125°C)	t_c	– –	200 310	300 –	ns

2. Proper strike and creepage distance must be provided.

TYPICAL STATIC CHARACTERISTICS

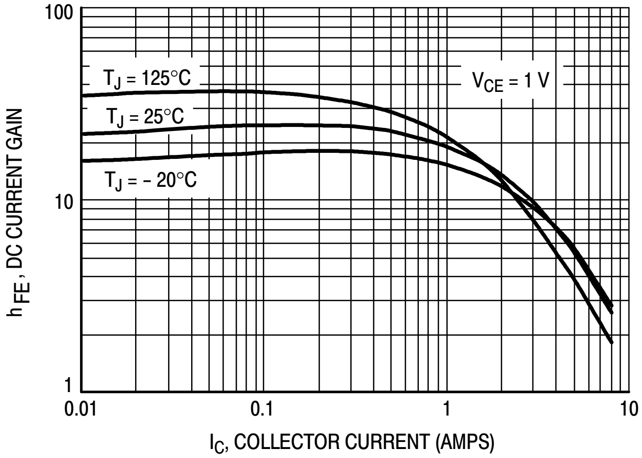


Figure 1. DC Current Gain @ 1 Volt

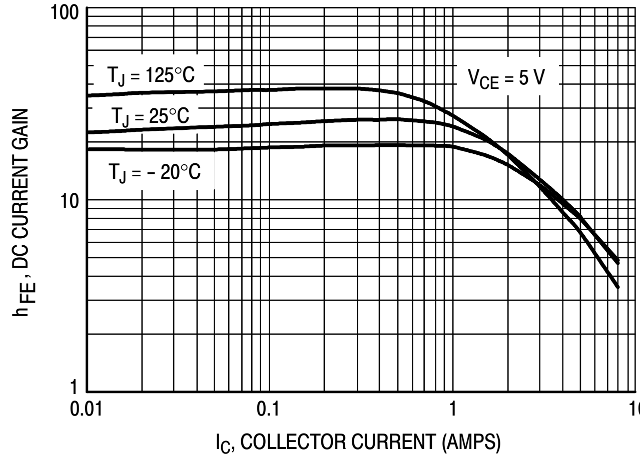


Figure 2. DC Current Gain @ 5 Volts

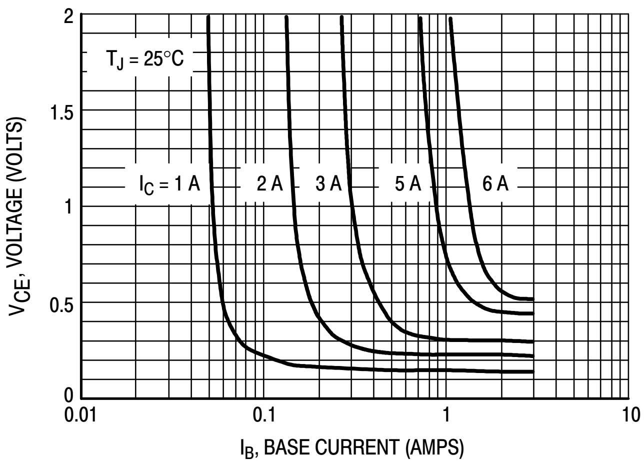


Figure 3. Collector Saturation Region

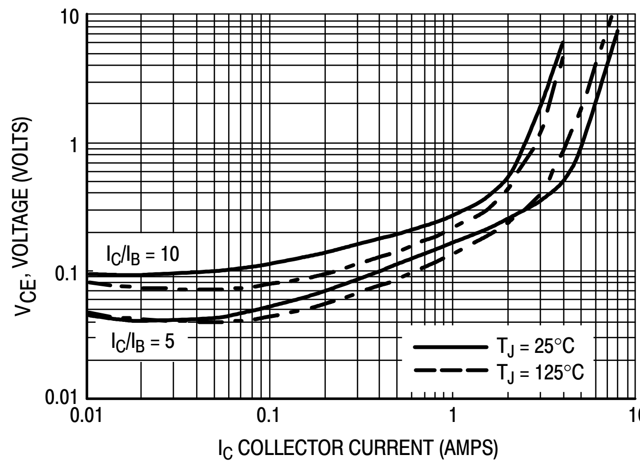


Figure 4. Collector−Emitter Saturation Voltage

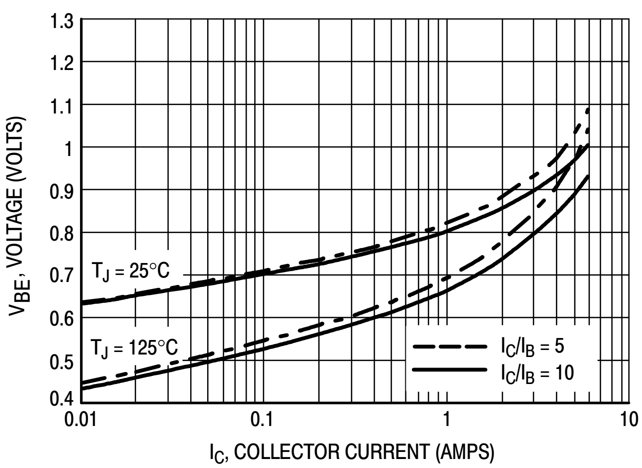


Figure 5. Base−Emitter Saturation Region

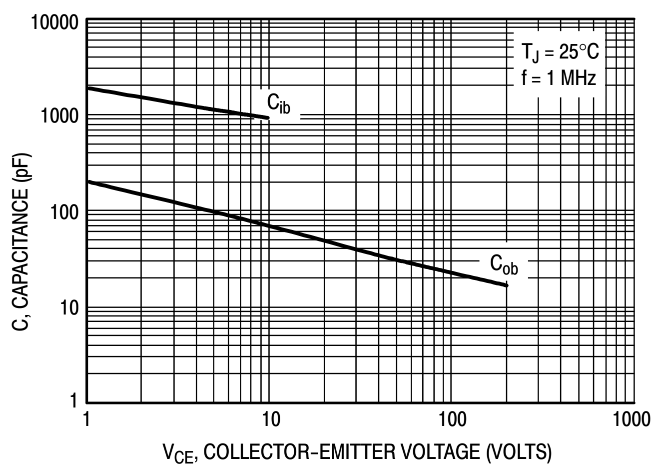


Figure 6. Capacitance

TYPICAL SWITCHING CHARACTERISTICS
(I_{B2} = I_C/2 for all switching)

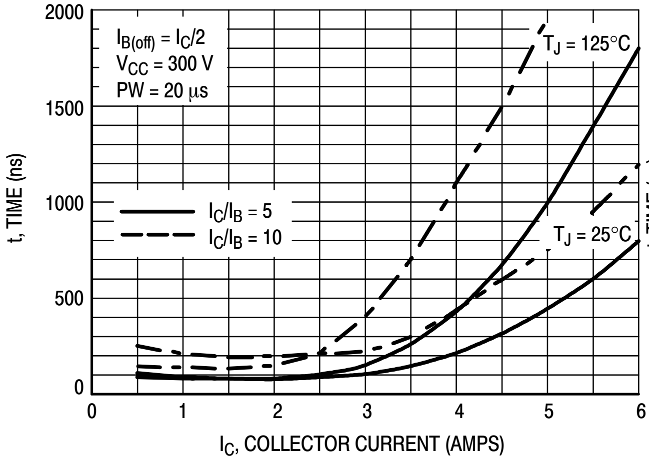


Figure 7. Resistive Switching, t_{on}

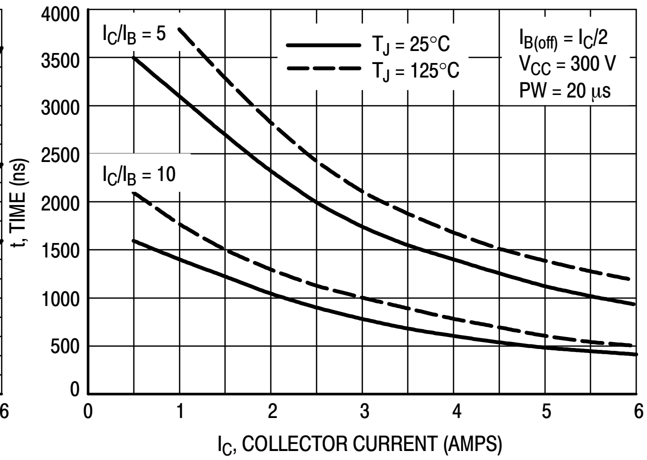


Figure 8. Resistive Switching, t_{off}

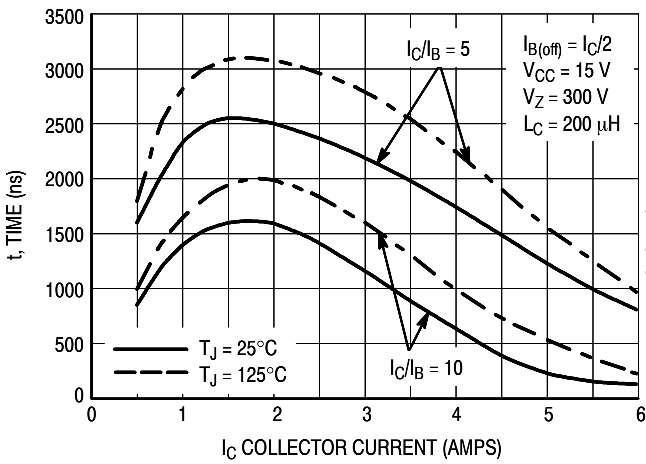


Figure 9. Inductive Storage Time, t_{si}

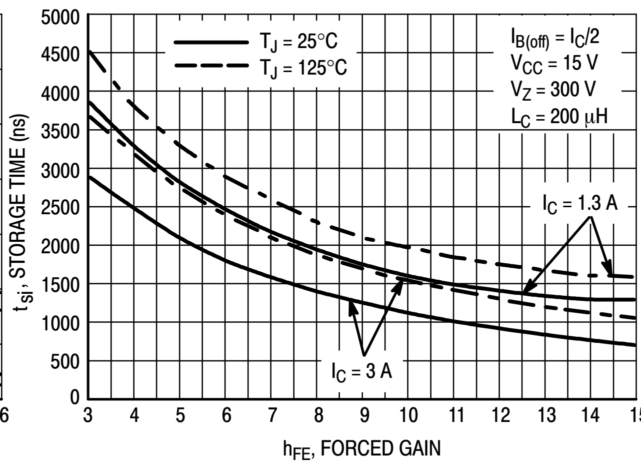


Figure 10. Inductive Storage Time, $t_{si}(h_{FE})$

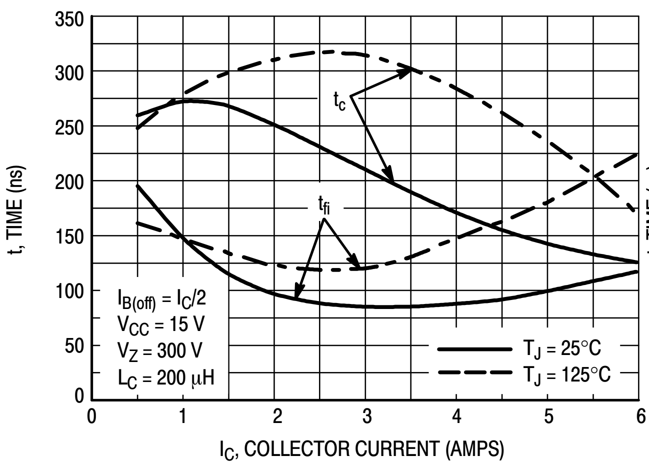


Figure 11. Inductive Switching, t_c and t_{fi}
I_C/I_B = 5

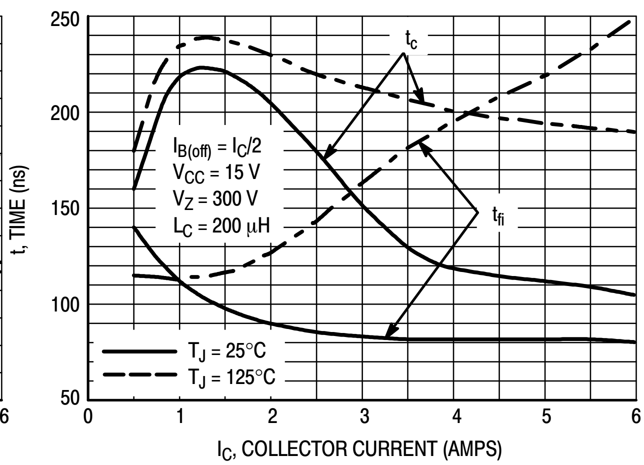


Figure 12. Inductive Switching, t_c and t_{fi}
I_C/I_B = 10

TYPICAL SWITCHING CHARACTERISTICS
($I_{B2} = I_C/2$ for all switching)

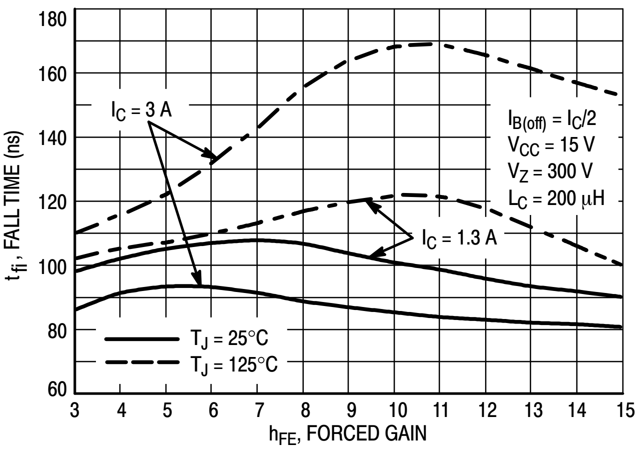


Figure 13. Inductive Fall Time

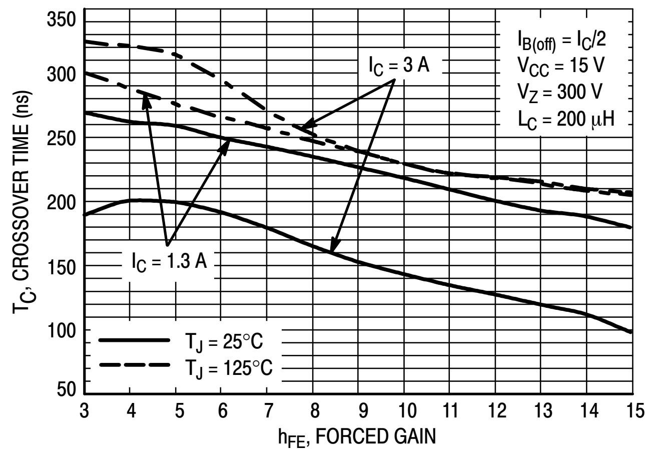


Figure 14. Inductive Crossover Time

GUARANTEED SAFE OPERATING AREA INFORMATION

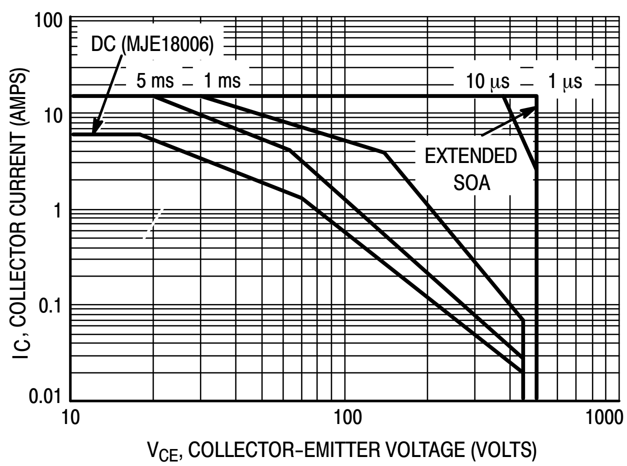


Figure 15. Forward Bias Safe Operating Area

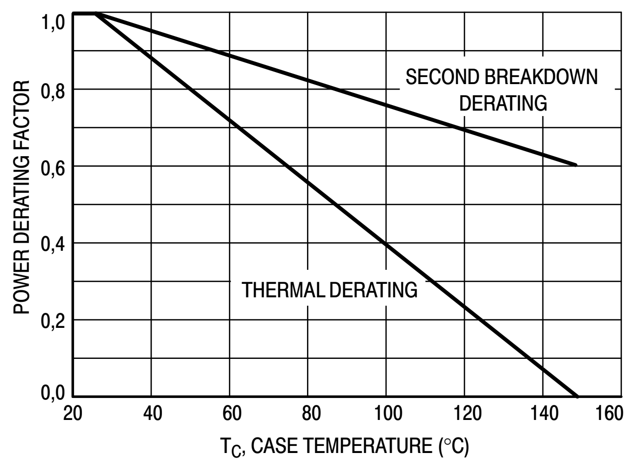


Figure 17. Forward Bias Power Derating

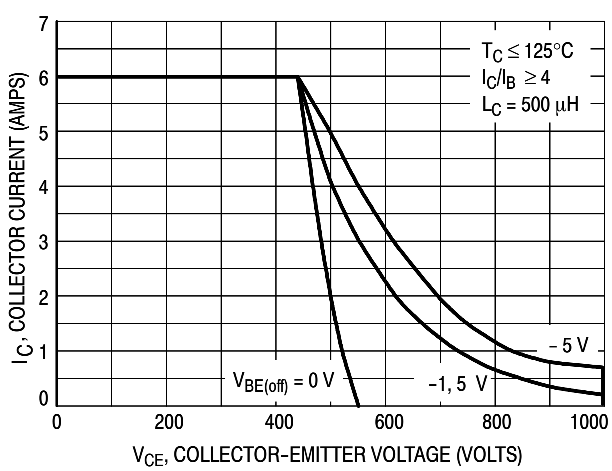


Figure 16. Reverse Bias Switching Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 15 is based on $T_C = 25°C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \geq 25°C$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown in Figure 15 may be found at any case temperature by using the appropriate curve on Figure 17. $T_{J(pk)}$ may be calculated from the data in Figure 20. At any case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. For inductive loads, high voltage and current must be sustained simultaneously during turn–off with the base–to–emitter junction reverse–biased. The safe level is specified as a reverse–biased safe operating area (Figure 16). This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.

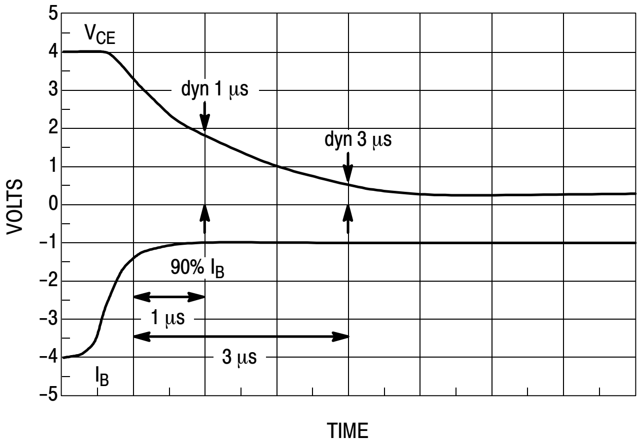


Figure 18. Dynamic Saturation Voltage Measurements

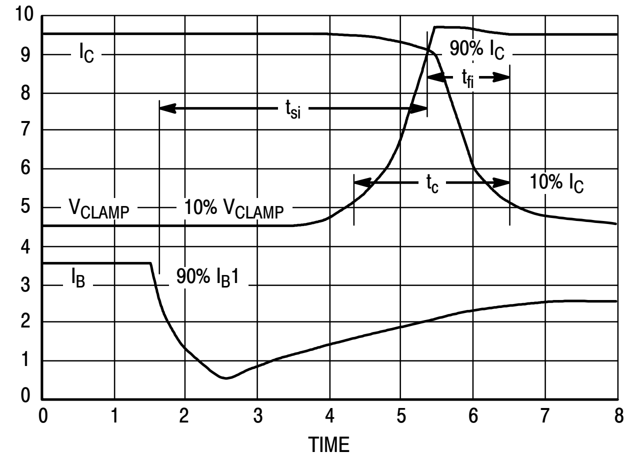
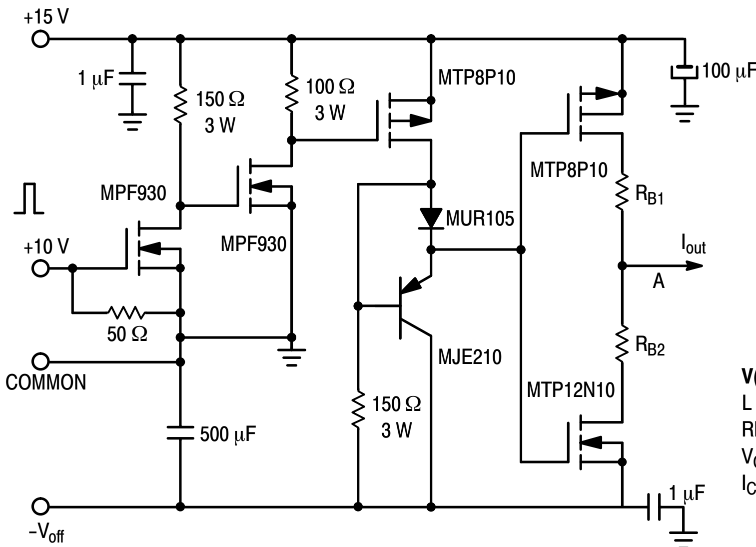
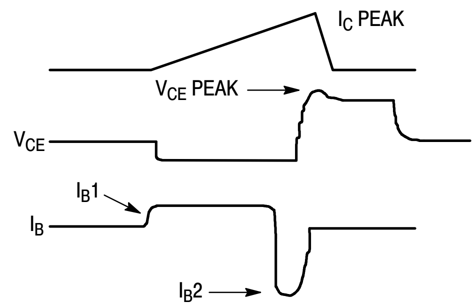


Figure 19. Inductive Switching Measurements





V(BR)CEO(sus)	INDUCTIVE SWITCHING	RBSOA
L = 10 mH	L = 200 μH	L = 500 μH
RB2 = ∞	RB2 = 0	RB2 = 0
V_{CC} = 20 VOLTS	V_{CC} = 15 VOLTS	V_{CC} = 15 VOLTS
I_C(pk) = 100 mA	RB1 SELECTED FOR DESIRED I_B1	RB1 SELECTED FOR DESIRED I_B1

Table 1. Inductive Load Switching Drive Circuit

TYPICAL THERMAL RESPONSE

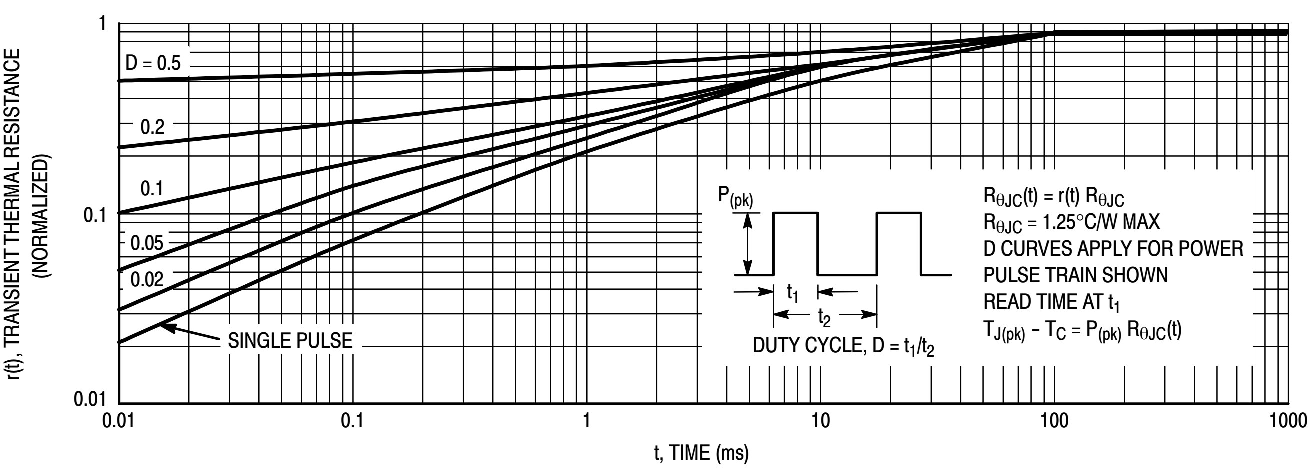


Figure 20. Typical Thermal Response ($Z_{\theta JC}(t)$) for MJE18006

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:
Technical Library: www.onsemi.com/design/resources/technical−documentation
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